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NASCAP Surface Charging Tool Development

Nascap-2k Additional Examples

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National Aeronautics and Space Administration

Langley Research Center Hampton, Virginia 23681-2199 Prepared for Langley Research Center under Contract 80NSSC20P2022 The use of trademarks or names of manufacturers in the report is for accurate reporting and does not constitute an official endorsement, either expressed or implied, of such products or manufacturers by the National Aeronautics and Space Administration.

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1 Introduction

Nascap-2k is a spacecraft charging and plasma interactions code designed to be used by spacecraft designers, aerospace and materials engineers, and space plasma environments experts to study the effects of both the natural and spacecraft-generated plasma environments on space systems. This document consists of examples constructed to illustrate the use of *Nascap-2k* to analyze moderately complex interactions between spacecraft surfaces and the plasma environment. These examples augment those included in the *Nascap-2k User's Manual* distributed with the code. The narrative below assumes familiarity with the use of *Nascap-2k* and the field of spacecraft-environment interactions. Specific results may be slightly different from those given here due to small differences in the geometry, material selection, and version of *Nascap-2k*.

The object, project, and grid files are included in the Manuals folder, along with the documentation.

2 Charge Plate Analyzer

A simple Surface Charging Detector has been proposed¹ and flown². A simplified circuit for this device is shown in Figure 1. The upper part of this circuit represents the resistance and capacitance of a dielectric surface to its underlying conductor, which is an isolated metal plate. The lower part of the circuit represents a physical capacitor and physical resistor that couple the plate to spacecraft ground. The instrument measures the potential difference between the plate and spacecraft ground.

In this example, *Nascap-2k* is used to study the response of a simplified version of the Charge Plate Analyzer (CPA) to rapid changes in the environment. The capacitive and resistive coupling between conductive elements are used to explicitly model the components in the lower part of Figure 1. The upper part of Figure 1 is modeled by setting the thickness, dielectric constant, and bulk conductivity of the surface material.



Figure 1. Simplified circuit for the Charge Plate Analyzer. The upper portion of the figure represents the properties of a dielectric coating, while the lower portion of the figure shows the measurement circuit.

2.1 Create model of spacecraft with CPA

The spacecraft for this example is a conductive box with a patch on the side to represent the instrument.

2.1.1 Create spacecraft body

Open *Object Toolkit*. Create a Box that is zoned $7 \times 7 \times 7$, has dimension $1.4 \text{ m} \times 1.4 \text{ m} \times 1.4$ m and has all surfaces graphite and conductor 1.

2.1.2 Define the CPA1 material

The CPA has an area of 25 cm² and a dielectric thickness of 0.002 inches $(5 \times 10^{-5} \text{ m})$. Click the **Material** menu and select "New...". Initially the **Material Definition** dialog box shows default Kapton properties. Set the material thickness to be 5×10^{-5} m. To obtain the capacitance and resistance shown in the circuit, use a dielectric constant of 1.129 and bulk conductivity of 5×10^{-14} ohms⁻¹ m⁻¹. Set the surface resistivity to be of 7×10^{11} ohms/square. For the purposes of this example, leave the remaining properties as those of default Kapton. Finally, select a distinctive color to represent the material, and click "OK".

2.1.3 Subdivide to form CPA surface elements

The process of subdividing the central element to form the CPA instrument is shown in Figure 2.

- 1. Select the element at the center of the +Z face of the cube. Subdivide the element. Then subdivide each of the four subelements. The original element is now replaced by 16 subelements, each of which is 5 cm square.
- 2. Delete the 12 subelements around the periphery of the original element, leaving the four subelements in the center.
- 3. Define four parallelogram elements to mesh compatibly with the 20 cm elements that make up the bulk of the face. For each of these new elements you will need to select the four nodes of the element in counterclockwise order, and click the "Create Element" menu tem of the **Mesh** menu.
- 4. Subdivide the four central elements and delete the twelve elements around their periphery, similar to step 2 above.
- 5. To maintain the 2.5 cm resolution on the CPA, use alternate parallelogram and triangle elements to connect the CPA to the outer parallelogram elements.
- 6. Correct the materials. The added elements default to Kapton, and must be converted to Graphite. Set the central four elements to be the CPA1 material and set their underlying conductor number to be 2. If the spacecraft had multiple CPAs, each would be assigned a different conductor number.
- 7. Save the object and exit *Object Toolkit*.



Figure 2. Steps to define the CPA instrument on the face of the spacecraft.

(a) delete element; (b,c) divide elements; (d) delete elements; (e,f) create elements; (g) divide and delete elements; (h) create elements; (i) assign materials; (j) assign conductors.

2.2 Initialize project

Open Nascap-2k and import this object into a new Nascap-2k project.

On the **Problem** tab, specify the problem as "Geosynchronous" "Surface Charging" with "Analytic Currents".

On the **Environment** tab, select the "Worst Case" environment and set the "Relative Sun Intensity" to 0.0 (eclipse condition).

On the **Applied Potentials** tab. Set conductor 1 (Spacecraft Ground) to be floating at an initial potential of 0 V. Set conductor 2 (CPA underlying conductor) to be floating at an initial potential of 0 V. To match the circuit components of Figure 1, set capacitive coupling of 5×10^{-8} farads between the two conductors, and set resistive coupling of 10^9 ohms between the two conductors.

<u>File Edit View Materials H</u> elp		Description in the							
Problem Environment Applied Po	otentials Charging	Space Potentials	Particles Scrip	Results	Results 3D				
Geosynchronous Environment									
14/2	rat Casa	Directi	on to Sun ———						
vvo	Inst Case	X:0.0	Y: 0.0	Z:	1.000				
Max	xwellian 💌								
			Relative* Sun Inter	sity: 0.0					
Electron Density (m ⁻³): 1.12	2E6 0.0		*(value at Spacecraft)	/ (value at Earth	Orbit)				
Electron Temperature (eV): 1.2E	E4 0.0		Use photoer	nission spectr	a				
Ion Density (m ⁻³):2.36	6E5 0.0	Particle	Species						
Ion Temperature (eV): 2.95	5E4 0.0	Тур	e Mass (amu)	Charge (C)	%				
Electron Kappa: 0.0		Electron	5.4858E-4	-1.6022E-19	100.000				
lon Kappa: 0.0	0.0								
Edit	t Measured								
Electron Current (Am ⁻²): 3.28	89E-6								
lon Current (Am ⁻²); 2.53	36E-8		Add Species	Delete Speci	es				
Magnetic Field (T)									
Bx:0.0 By:0.0	Bz: 0.0								

Figure 3. Environment tab values for the CPA example.

<u>File Edit View Materials H</u> elp										
Problem Environm	ent Applied Potentia	als Charging	g Space P	otentials	Particles	Script Resu	Its Results 3	3D		
Conductor Potentials	and Biasing									
First Conductor Connectivity		ity S	Second Cond	luctor	Value (V)		Initial Potentia	I (V)		
1 Floating Potential								0.0		
2 Floating Potential								0.0		
- Applied Resistance an First Conduct	Applied Resistance and Capacitance First Conductor Connectivity Second Conductor Value (F or ohms)									
2	Resistively	Coupled with	1					1.0E9		
		Add Ca	pacitance	Add Resi	stance	Delete Row	Show as T	ables		
Insulator Surface Pote	entials —									
Material	Conductor	Sunlit/Da	ark	Surfaces		Туре	Initial Poten	tial (V)		
						Add Ro	w Delete	e Row		

Figure 4. Applied Potentials tab values for the CPA example.

On the **Charging** tab, use the default of charging for 300 seconds with 45 timesteps in the range of 0.1 to 60 seconds.

On the **Script** tab, build the script. Expand the **Charge Surfaces** command, and then the "SetCircuit" second level command to observe that the capacitance and conductance correspond to the values entered on the **Applied Potentials** tab. Click the "Run Script" button to execute the script.

<u>File</u> <u>E</u> dit	View Materials	<u>H</u> elp							
Problem	Environment	Applied Potentials	Charging	Space Potentials	Particles	Script	Results	Results 3D	1
	Chai	rging Time ———— Parameters ————]		
		Duration (sec)	:300.0	Number of T	imesteps: 45]		
		Min Timestep (sec)	0.100	Max Times	step (sec): 60.	00			
	۲ F	Resulting Times (sec	s)						
		0	2.804	16.97	88.54				
		0.1	3.309	19.52	101.4				
		0.2145	3.887	22.44	116.2				
		0.3454	4.549	25.79	133.1				
		0.4954	5.307	29.61	152.4				
		0.667	6.174	33.99	174.5				
		0.8633	7.166	39.01	199.9				
		1.088	8.301	44.74	228.9				
		1.345	9.601	51.31	262				
		1.64	11.09	58.83	300				
		1.977	12.79	67.43					
		2.362	14.74	77.27					

Figure 5. Charging Tab for CPA example.



Figure 6. Script tab for CPA example.

2.3 Examine results in eclipse condition

On the **Results** tab, define two "Surface Element Groups" corresponding to conductors 1 and 2. Select both groups, as well as both conductors in the "Conductors" panel. Select "Potential". Note that the entire spacecraft has charged to -27 kV.

Select "Differential Potential". On the **Graph** subtab click "Plot", and note that the CPA surface has charged to a positive differential of about 70 V. The **Text** subtab shows that the CPA has a differential potential of 69.89 V (relative to its underlying conductor 2), but, as shown in the left panel, a differential potential relative to chassis of 70.11 V. The difference of 0.22 V is the measured potential of conductor 2 relative to chassis, and, as a 400:1 resistive divider, predicts a differential potential of 88 V on the CPA surface, which is reasonable as the CPA is continuing to differentially charge at about 0.1 volts per second.

Select "Charging Current". On the **Graph** subtab click "Plot". On the **Text** subtab note that the CPA surface is subject to charging current of 9.3×10^{-8} Am⁻². Accounting for the CPA area of 25 cm², this predicts a voltage of 0.23 V across the 10⁹ ohm CPA resistor, and a steady-state differential potential of 92 V on the CPA surface.

Note that the shorter RC time constant of the CPA measurement circuit makes it a good predictor of the eventual CPA differential potential for this case.

2.4 Examine results in sunlit condition

On the **Environment** tab, set the "Direction to Sun" to be (0, 0, 1) and the "Relative Sun Intensity" to be 1.0, so that the face of the spacecraft containing the CPA is sunlit.

On the **Charging** tab, reduce the duration of the calculation to 120 seconds with no change in the other parameters.

On the **Script** tab, go to the **Edit Script** subtab. In order to continue the previous calculation with the new parameters, delete the **Read Object** command and expand the **Charge Surfaces** command and delete the "SetInitialConductorPotentials" second level command. Confirm that the attributes of the "SetIllumination" second level command reflect the values entered on the **Environment** tab. Click the "Run Script" button to execute the script.

On the **Results** tab, select "Potential" and click "Plot". Note that the spacecraft potential rises from -27 kV to about -6 kV due to the sudden onset of sunlight.

Select "Differential Potential" and click "Plot". Note that the differential potential on the CPA has dropped rapidly to about 40 V. On the **Text** subtab, note that the CPA surface differential is oscillating with amplitude of about 0.5 V. This makes it difficult to infer the CPA measurement voltage, which should be about 0.1 V. Note that the "Charging Current" to the CPA is also oscillating as the photoelectron suppression is turned on and off by the small changes in surface potential.

2.5 Examine results in shadowed condition

On the **Environment** tab, set "Direction to Sun" to be (0, 0, -1) and the "Relative Sun Intensity" to 1.0, so that the face of the spacecraft opposite the CPA is sunlit.

On the **Charging** tab, restore the duration of the calculation to 300 seconds.

On the **Script** tab, no further changes should be required. Check that the parameters are correct. Click the "Run Script" button to execute the script.

On the **Results** tab, select "Potential" and click "Plot". Note that the spacecraft potential remains at about -6 kV, but the CPA is differentially charging negative.

Select "Differential Potential" and click "Plot". The **Text** subtab shows that the CPA surface is at -630.4 V relative to its underlying conductor. Since the CPA surface is the minimum potential in the problem, and the chassis potential is the maximum potential, the table in the left panel shows that the CPA is at -632.5 V relative to chassis. This means the CPA must be measuring -2.1 V, suggesting a steady-state CPA surface differential of -840 V.

2.6 Examine CPA measured potentials

At this writing the *Nascap-2k* interface does not provide enough digits in the potential history display to accurately determine the measured potential difference between the CPA backplate (conductor 2) and spacecraft ground (conductor 1). However, this information can be obtained from the .log file, which contains lines such as

```
cond. 0 isBiased=0 bias=0.000000 potl=-1851.127063
cond. 1 isBiased=0 bias=0.000000 potl=-1851.134644
```

Use a search utility to extract those lines and import them to a spreadsheet. Subtract the potential values to obtain the time history of the CPA measurement. Plot this along with the CPA surface differential potential. The result is shown in Figure 7. The differential potential on the CPA material is plotted against the left-hand axis and the difference between the two conductors is plotted against the right-hand axis.



Figure 7. Time history of CPA surface differential potential (left axis) and measurement potential (right axis) for the eclipse, sunlit, and shadowed portions of the calculation.

2.6.1 Eclipse period

It takes about four seconds (14 timesteps) for the entire spacecraft to charge to its steady-state potential of -26 kV. For the remainder of the eclipse period, the charging current to the CPA is fairly constant.

For the next few seconds the ratio between the CPA surface differential and the CPA measurement voltage is about 100:1, as determined by the ratio of capacitances. For example, at 6.17 seconds the surface differential is 11.79 V while the CPA measurement is 0.1144 V.

During the remainder of the period, the CPA measurement remains fairly constant while the surface differential continues to rise, as the circuit transitions from a 100:1 capacitive divider to a 400:1 resistive divider. At the end of the eclipse period (300 s) the surface differential is 69.89 V and the CPA measurement is 0.2196 V, a ratio of 318:1.

2.6.2 Sunlit period

The sudden onset of sunlight causes a sharp transient as the spacecraft potential rises to -6 kV. The CPA surface differential first rises and then drops to 40 V, the potential at which photoelectron emission is marginally limited by an electric field barrier. This net drop of 30 V corresponds to a 0.3 V drop (governed by the 100:1 capacitive divider) in the CPA measurement voltage. At this point the CPA measurement voltage of -0.06 V is giving a completely erroneous indication of the actual 40 V surface differential.

During the remainder of the sunlit period, the CPA measurement potential rises toward a correct indication of the 40 V surface differential. At the end of the sunlit period (420 s) the surface differential is 39.18 V and the CPA measurement is 0.0764 V, a ratio of 513:1.

2.6.3 Shadowed period

During the shadowed period, the charging current to the CPA surface again varies slowly with potential. The CPA measurement initially drops at 1/100 the rate of drop in surface differential. Eventually the CPA measurement saturates at -2.06 V (predicting a surface differential of -824 V) while the surface differential continues to drop. At the end of the shadowed period (720 s) the surface differential is -630.4 V (and dropping) and the CPA measurement is -0.2065 V, giving a ratio of 305:1 (and rising).

2.6.4 Discussion

After a transient change in conditions, the CPA measurement changes at 1/100 the rate of change of the surface potential, as dictated by the capacitors in the circuit—that is, the instrument behaves as a capacitive divider. It takes a minute or more for the ratio of the two potentials to approach 400:1, as dictated by the resistors in the circuit. During the intervening time the measurement can be quite misleading, especially if there is a change in sign of either potential.

In Figure 8, after each transient change, the ratio of the time derivatives (slope ratio) of the surface potential and CPA measurement voltage takes the value of 100 (capacitance ratio) and rapidly rises or shifts to erratic behavior. The ratio of the values of those quantities may behave erratically following the transient change, but eventually drifts toward a steady-state value of 400 (resistance ratio).



Figure 8. Time dependence of the ratio of the surface differential to the CPA measurement voltage, and the ratio of the time derivatives of those quantities.

Specifically considering the sunlit period (Figure 9), from 300 to 306 seconds, the ratio of the slopes is near 100 (capacitive divider) as the differential potential rapidly drops from \sim 70 V to \sim 40 V (Figure 7) and the CPA measurement drops from 0.35 V to -0.05 V. From 306 to 318 seconds, the slope of the CPA measurement is near zero while the differential potential varies within a narrow range to seek the right potential for efield limiting. The ratio of the slopes is not a useful measure during this period. Finally, from 318 to 420 seconds the differential potential is nearly constant (so the ratio of the slopes is near zero) as the CPA measurement rises through zero to approach a 400:1 resistive divider value ratio from above. Thus depending on the system history, the 400:1 ratio may be approached from above or below.



Figure 9. Time dependence during the sunlit period of the CPA measurement voltage (left axis), and the ratio of the time derivative of the surface differential potential to the time derivative of the CPA measurement (right axis).

3 Tether Voltage

The following example illustrates the use of resistive coupling to explore the effects of resistance on a simple tethered system model. To make this example as simple as possible, orbit-limited current collection models that do not adequately represent the actual current collection in a dense low-Earth-orbit plasma environment are used. The simplifications are discussed at the end of this description.

In the coordinate system used, \hat{x} points East, \hat{z} points down, and \hat{y} points South. The spacecraft velocity is taken to be eastward (positive \hat{x}), and the magnetic field northward (negative \hat{y}). Imagining a spacecraft to be a perfect conductor, the force on an electron in that conductor must be zero (or else infinite current will flow). Viewing the spacecraft from the external plasma, the downward magnetic induction force must be balanced by an upward electric force, so the top of the spacecraft is at positive potential relative to the bottom. Charge conservation requires that electrons collected at the positive (top) end be balanced by ions collected at the negative (bottom) end, so that current flows upward (electrons flow downward) through the spacecraft.

The top-to-bottom potential difference *cannot* be measured by conventional meters and probes, as the probe leads are subject to the same magnetic induction force as the spacecraft itself. The potential difference *can* be measured using Langmuir probes (which measure the difference between local spacecraft ground and local plasma potential) at the top and bottom of the spacecraft. The potential difference can also be inferred by interrupting the current flow with a resistor.

3.1 Object definition

The spacecraft for this example is constructed of three components: an upper body, a tether stub, and a lower body. The upper body is 200 m above the lower body. The tether connecting the two is taken to influence the potentials only by its resistance and is therefore represented only by the tether stub in the geometry.

3.1.1 Create upper body

Create a Box that is zoned $3 \times 3 \times 3$, has dimension $1 \text{ m} \times 1 \text{ m} \times 1 \text{ m}$, and has all surfaces aluminum and conductor 1. Select the component and, using the "Place" menu item on the **Component** menu, move the box to a temporary location at Z = -5 m.

3.1.2 Create tether stub

Create a Boom that is zoned $1 \times 1 \times 2$ and has dimension $0.1 \text{ m} \times 0.1 \text{ m} \times 1\text{m}$. Make the surfaces Graphite and conductor 2. Select a node on the +Z end of the boom and using the "Node Relative Move" menu item on the **Component** menu move it to a position of Z = -1.1 m and centered in X and Y.

3.1.3 Create lower body

Create a Cylinder with 12 circumferential zones, 8 zones along its height, a height of 8 meters, and a diameter of 2 meters. Make the surfaces Gold and conductor 3. Select an edge parallel to the cylinder axis and, using the "Align Edge" menu item on the **Component** menu make that edge parallel to the Y axis. Viewing the cylinder from the -X direction, select the node at the center of the cylinder and move it to position (-1, 0, 0).

3.1.4 Move upper body

At this point the object should appear as shown in Figure 10 (with y-axis pointing right and z-axis pointing down). Select the upper body and use the "Place" menu item on the **Component** menu to move the upper body from Z = -5 m to Z = -200 m. Zoom out to assure the operation has been done correctly. Save the object.



Figure 10. View of tether example object prior to moving upper body to -200 m. (View from –X direction with Z downward.)

3.2 Initialize project

Import this object into a new *Nascap-2k* project.

- 1. On the **Problem** tab, specify the problem as "LEO or Plume" "Surface Charging" with "Analytic Currents".
- 2. On the **Environment** tab (Figure 11), set the electron and ion densities to be 10^9 m^{-3} and the electron and ion temperatures to be 1 eV. Specify a northward magnetic field of $B_y = -3 \times 10^{-5} \text{ T}$. Specify eastward spacecraft velocity $V_x = 7500 \text{ ms}^{-1}$. Specify zero sun intensity, and define the Oxygen ion species. This environment is selected to produce plasma-induced potentials small compared with the magnetically induced potential while having enough current to be influenced by reasonable resistive terms to be introduced below.
- 3. On the **Applied Potentials** tab (Figure 12)
 - a. Set conductor 1 (Upper Body) to be floating at an initial potential of 0 V.
 - b. Set conductor 2 (Tether Stub) to be biased relative to conductor 1 at potential difference of 0.0 V. This bias plays the role of the physical tether (which need not be defined), with the logical connection taking the place of a physical connection.
 - c. Set conductor 3 (Lower Body) to biased relative to conductor 1 at potential difference of 0.0 V. This sets the entire system to be effectively a single conductor.

🗟 Nascap2k - C:\Nascap2k\VXBTest2\VXBTest2Project.xml – 🗆 🗙									
<u>File E</u> dit View Materials Help									
Problem Environment Applied Potentials Charging Space	Potentials Particles Script Results Results 3D								
LEO or Plume Environment									
r LEO Environment Plasma — r Sun —									
Density (m ⁻³): 1.000E9	Direction to Sun								
Temperature (eV): 1.000	X: 1.000 Y: 0.0 Z: 0.0								
Debye Length (m);0.235	Relative* Sun Intensity:0.0								
Electron Current (Am ⁻²):2.681E-5	*(value at Spacecraft) / (value at Earth Orbit)								
Ion Current (Am ⁻²): 1.570E-7	Particle Species								
	Type Mass (amu) Charge (C) %								
Magnetic Field (T)	Electron 5.4858E-4 -1.6022E-19 100.000								
Bx 0.0 By -3.000E-5 Bz 0.0	Oxygen 16.0000 1.6022E-19 100.000								
Spacecraft Velocity with Respect to Plasma (m/s)									
Vx 7500. Vy 0.0 Vz 0.0									
	Add Species Delete Species								

Figure 11. Environment tab values for the Tether example.

<u>File E</u> dit View Materials Help									
Problem Environme	nt Applied Potentia	als Ch	arging S	ipace Potentials	Particles	Script	Results	Results 3D	
Conductor Potentials a	nd Biasing								
First Conductor Connectivity		ity	Secon	d Conductor	Valu	ue (V)	Initi	al Potential (V)	
1 Floating Potential									0.0
2 Bias Potential from		1	1				0.0		0.0
3	3 Bias Potential from		1				0.0		0.0
- Annlied Resistance and									
First Conducto	r	Connecti	wity	Seco	ad Conductor		Value (For ohme)	
- Thist Conducto		Connect	vity	0600	Id Conductor		Value (i or onna)	
Coupling requires i	ndependent conducto	rs A	dd Capacita	ance Add F	Resistance	Delete	Row	Show as Table	es
r Insulator Surface Poten	tials —								
Material	Conductor	Su	nlit/Dark	Surfac	es	Туре	1	nitial Potential ((V)
						4	dd Row	Delete Ro	w

Figure 12. Applied Potential tab for Tether example.

- 4. On the **Charging** tab, specify charging for 3 seconds using 10 timesteps with a minimum of 0.1 seconds and a maximum of 1.0 seconds.
- 5. On the **Script** tab, build the default script. The script should now appear as shown in Figure 13. Note the presence of the "SetBField" and "SetVelocity" second level commands, and the initialization of $\mathbf{v} \times \mathbf{B}$ potentials ("Set VXBPotentials") prior to the

"DoTimeSteps" second level command. Click the "Run Script" button to execute the script.

<u>File Edit View Materials Help</u>					
Problem Environment Applie	d Potentials Charging	Space Potentials	Particles Script	t Results	Results 3D
Run Script Edit Script Commands Edit Script Loop Read_Object Append_Object Initialize_Potentials Charge_Surfaces DoOneTimeStep DoTrackTimeStep DoTrackTimeStep EmitCurrent ReadPhotoemission SetBField SetCircuit SetCustomCurrentDLL SetEnvironment SetIllumination SetWelocity SetVelocity SetVelocity SetVelocity SetVaBPotentials UseTrackedCurrent UseTrackedCorrent Bernackdons Embed_Object_in_Grid Potentials_in_Space Static_A_Field	Contracts Con	Script C Char C C Char C C S C S	d_Object gge_Surfacess betillumination	Val	
	Build Script S	ave Files	Automatically overw	rite files	Run Script
			,		4.

Figure 13. Script tab for Tether example.

3.3 Examine results with all components connected

On the **Results** tab, select "Potential". To see the $\mathbf{v} \times \mathbf{B}$ potentials it is necessary to look at the surfaces rather than the conductors, which are not localized. In the top panel, add two additional "Surface Element Groups" for a total of three. In the "Conductor" column specify the conductors 1, 2, and 3. Check all three "Plot" checkboxes and click the "Plot" button.

On the **Text** subtab, note that the upper body reaches steady state at an average potential of 6.9 V, the tether stub at -37.8 V, and the lower body at -38.2 V. Next plot the "Charging Current". The average current to the upper body is -210 μ A m⁻², while the average current to the lower body is +22.4 μ A m⁻². Accounting for the surface areas of 6 m² for the upper body and 55.7 m² for the lower body gives that the upper, electron-collecting body collects -1.26 mA, while the lower, ion-collecting body collects 1.25 mA, with ions collected by the tether stub making up the difference.

3.4 Examine results with lower body floating.

On the **Applied Potentials** tab, change the lower body (conductor 3) from biased to floating. Return to the **Script** tab. The script has been automatically updated to reflect the change. Click the "Run Script" button to execute the script.

On the **Results** tab, select "Potential" and plot the three surface element groups. On the **Text** subtab, note that the upper body reaches steady state at an average potential of -1.96 V, the tether stub at -46.6 V, and the lower body at -2.53 V. Next plot the "Charging Current". The lower

body averages near zero charging current, while the upper body is slightly more positive, with its net electron current balanced by ions collected by the tether stub.

3.5 Examine results with lower body resistively coupled

Return to the **Applied Potentials** tab. Click the "Add Resistance" button to add a row in the "Applied Resistance and Capacitance" table. Set the resistance between the lower body and tether stub (conductors 3 and 2) to be $30 \text{ k}\Omega$ (3×10⁴ ohms).

Return to the **Script** tab and expand the "SetCircuit" second level command to note that it contains a conductance that is the reciprocal of the resistance entered above. Click the "Run Script" button to execute the script.

On the **Results** tab, note that the three components reach steady state potentials of 3.4 V, -41 V, and -21 V, each component approximately midway between the previous two cases.

Repeat the calculation with resistance values of 1000Ω , $10 k\Omega$, $100 k\Omega$, and $1 M\Omega$. The results for the upper body, the lower body, and the measurable difference V2-V3 (the tether stub potential as measured from the lower body) are shown in Figure 14.



Figure 14. Potential of upper body (V1, upper curve), lower body (V3, upward sloping curve) and the measurable difference (V2-V3) as a function of tether root coupling resistance. Note that the end points (100 Ω , 10 M Ω) are actually the shorted (Section 3.3) and floating (Section 3.4) cases respectively.

3.6 Discussion

When resistance is included in a simple tether model, the upper body has maximum potential when grounded (or coupled by low resistance) to the lower body, and minimum potential when decoupled (or coupled by high resistance) from the lower body.

The above simulation uses orbit-limited currents (maximum currents) to each body, ignoring the effects of sheath and magnetic field limiting. To do this correctly in *Nascap-2k*, a computational grid is constructed about the upper and lower bodies and the sheath currents computed. In the above, at the maximum potential of 6.9 V, the upper body collects 1.3 mA of electrons. In fact, the magnetically limited current³ at this potential is only about 0.2 mA. This means the upper body can rise to considerably higher potential so that its electron current increases to match the lower body ram ion current.

To perform this calculation with tracked currents, see Section 4, "Tether Voltage with Tracked Currents", below.

4 Tether Voltage with Tracked Currents

The Tether Voltage example presented in Section 3 above illustrates the use of resistive coupling to explore the effects of resistance on a simple tethered system model. That example uses orbitlimited current collection models that do not adequately represent the actual current collection in a dense low-Earth-orbit plasma environment to make it as simple as possible.

In this example, the same system is modeled, using sheath limited ram ion collection on the lower body and magnetically limited and sheath limited electron collection on the upper body. Due to the large separation between the two bodies, this requires the construction of disjoint computational grids about the upper and lower bodies.

The system parameters, the coordinate system, and the geometry are the same as in the Tether Voltage example (Section 3).

4.1 Creating the grids about the upper and lower objects

In order to create separate computational grids about the upper body and lower body, the two components need to be in separate files.

4.1.1 Create upper body

Create a Box that is zoned $3 \times 3 \times 3$, has dimension $1 \text{ m} \times 1 \text{ m} \times 1$ m, and has all surfaces aluminum and conductor 1. Save to a file named case UpperObject.xml.

4.1.2 Create tether stub and lower body

On the **File** Menu, select "New Object". Create a Boom that is zoned $1 \times 1 \times 2$ and has dimension $0.1 \text{ m} \times 0.1 \text{ m} \times 1$ m. Make the surfaces Graphite and conductor 2. Select a node on the +Z end of the boom and using the "Node Relative Move" menu item on the **Component** menu move it to a position of Z = -1.1 m and centered in X and Y.

For the lower body, create a Cylinder with 12 circumferential zones, 8 zones along its height, a height of 8 meters, and a diameter of 2 meters. Make the surfaces Gold and conductor 3. Select an edge parallel to the cylinder axis and, using the "Align Edge" menu item on the **Component** menu make that edge parallel to the Y axis. Viewing the cylinder from the -X direction, select the node at the center of the cylinder and move it to position (-1, 0, 0). Save the object containing the tether stub and the lower body to a file **LowerObject.xml**.

4.1.3 Computational grids

Next define a grid structure about each object in the usual way. At present, it is necessary for both outer grids to have the same mesh spacing. Using different primary grid spacings causes potentials to be both wrongly calculated and displayed.

Open *GridTool* by selecting it from the *Windows Start Menu*. Import the upper object using "Import Object" on the **File** menu. From the **Grid** menu select "New Primary Grid". On the **Primary Grid** dialog box that appears, set the grid dimension to $48 \times 48 \times 48$ with a mesh size of 0.13 m. Click the "OK" button. Save the grid as UpperGrid.grd and exit *GridTool*.

Reopen *GridTool* and import the lower object. Set the grid dimension to $68 \times 128 \times 68$ with a mesh size of 0.13 m. Save the grid as LowerGrid.grd and exit *GridTool*.

The two grid files must be combined using the *CombineGrids* Java application. The jar for this application is included in the **Utilities** folder in the *Nascap-2k* installation, and can be run by double-clicking **CombineGrids.jar**. Figure 15 shows the user interface. Enter the full paths of the first and second grid files created and saved above. Enter the offset vector as "0.0, 0.0, -200.0" to set the center of the upper grid as 200 m anti-Earthward from the center of the lower grid. Enter the full path of output grid file with name "**GriddedTether.grd**". Click the "Combine" button to write out the combined grid file.

🕌 Combine Grids	– 🗆 X
st Grid File:	C:\Nascap2k\GriddedTether\LowerGrid.grd
nd Grid File:	C:\Nascap2k\GriddedTether\UpperGrid.grd
Offset vector [m]:	0.0 0.0 -200.0
Dutput Grid File:	C:\Nascap2k\GriddedTether\GriddedTether.grd
Combine Grids:	Combine

Figure 15. CombineGrids user interface.

4.2 Set up the project

Create a new project named "Tether" in a directory containing the new grid file (**GriddedTether.grd**), possibly the two component objects, and *no* other "GriddedTether" files.

Launch the *Nascap-2k* user interface and click the "Create New Project" button. Uncheck "Create New Folder" and click "Set Location" to place the project in the folder containing **GriddedTether.grd**. Assign the prefix "GriddedTether" to the project. Click "OK."

On the **File** menu select "Load Object...". Navigate to the primary object definition file (in this case **LowerObject.xml**), select it, and click "Open." The second object (**UpperObject.xml**) is added later through the script. The "Grid Status" should show the grid already loaded.

On the **Problem** tab, specify the calculation as "LEO or Plume" Environment and "Surface Charging" with "Tracked Particle Currents". "Potentials in Space or Detector Analysis", "Analytic Space Charge", and "Surface Currents" are automatically checked.

Set the **Environment** tab to have the parameters shown in Figure 11 for the Tether example.

Set the **Applied Potentials** tab to have the parameters shown in Figure 12 for the Tether example.

On the **Charging** tab, specify charging for 2×10^{-4} seconds using 10 timesteps with a minimum of 2×10^{-5} seconds. The script to be built performs charging one step at a time while looping through other commands. The timestep was chosen with hindsight to work well for the parameters of this problem.

On the **Space Potentials** tab, set the charge density model to be "Non-linear". Set the species for the Geometric Wake to be Oxygen. Set the "Target Average (RMS) Error (V)" to be 10^{-2} V.

On the **Particles** tab, the **Surface Currents** subtab should be displayed. Select "Sheath" with a "Potential Value" of 1 V. Check both particle species checkboxes. Click the "Advanced" button to bring up the **Advanced Particle Parameters** dialog box." On the "Tracking limits (m)" panel, uncheck the "Track throughout grid" checkbox. The X, Y, and Z bounds are in meters relative to the center of the primary grid, i.e., the lower body. Enter -999.0 for the X and Y lower values, and -9999.0 for the Z lower value. Enter 999.0 for the three upper values. (This is needed because the input files are written prior to running the script, before the initial steps of the script define the grid.) Later we will check the Tracker output file to see that these values are processed correctly. Click "OK" to exit the dialog.

The script used to create the combined object (as it appears on the **Script** tab) is shown in Figure 16. This can be built by adding commands to the script within the *Nascap-2k* interface. Alternatively, it may be written to a file and loaded by selecting "Load Script" on the **File** menu. Note that the (x,y,z) coordinates in the **Append Object** command correspond to the "Object Center Offset" displayed by *CombineGrids* and are not necessarily the same as the grid offset. The argument of the **Append Object** command is the full pathname to the second object, **UpperObject.xml**.

To create the script, on the **Script** tab, click "Build Script" to build the default script. As the script needs to be edited, switch to the **Edit Script** subtab. Highlight the **Read Object** command and add an **Append Object** command immediately following. Expand the **Append Object** command. In the FileName textbox enter the full path to **UpperObject.xml**. The x, y, and z values are the offsets entered previously in the *CombineGrids* interface (Figure 15). Enter -200.0 for the Z offset.

By default, the surface potentials are initialized to the values shown on the **Applied Potentials** tab. An additional **Charge Surfaces** command is needed to apply the $v \times B$ potentials. Highlight the **Embed Object in Grid** command and insert a **Charge Surfaces** command after it. Highlight the **ChargeSurfaces** command just inserted and insert the second level commands "SetBField", "SetVelocity", "SetCircuit", and "SetVXBPotentials". Expand the **Charge Surfaces** command and check that the magnetic field and velocity correspond to what was set on the **Environment** tab. Expand the "SetVXBPotentials second level command and note there is a value to be set. This value is the maximum potential on the object. Set this value to 6.0 volts, which was the result of the earlier "Tether" example. The script, with the items of interest expanded, should be similar to that shown in Figure 16.

Open the **Charge Surfaces** command that appears just above the **Loop** command. The "SetBField", "SetVelocity", and "SetCircuit" second level commands are not necessary as these parameters have already been set. Remove the "SetInitialConductorPotentials" second level command as the conductor potentials were already set by the "SetVXBPotentials" within the previous **Charge Surfaces** command. (See Figure 17.)

Open the **Charge Surfaces** command that appears within the **Loop** command. As all of the parameters have already been set, only the second level command "DoOneTimeStep", which instructs the code to take one charging timestep, is needed. (See Figure 17.)

Click the "Run Script" button to execute the script.



Figure 16. Script tab after adding Append Object and Charge Surfaces to the script.



Figure 17. Script tab showing the Charge Surfaces commands immediately preceding the Loop command and within the Loop command.

4.3 Examine results with all components connected.

4.3.1 Potentials and currents

On the **Results** tab, select "Potential". To see the $\mathbf{v} \times \mathbf{B}$ potentials we must look at the surfaces rather than the conductors, which are not localized. In the top panel, add two additional "Surface Element Groups" for a total of three. In the "Conductor" column specify the conductors 1, 2, and 3. Check all three "Plot" checkboxes and click the "Plot" button.

On the **Text** subtab, note that the upper body approaches steady state at an average potential of 8.9 V, the tether stub at -35.9V, and the lower body at -36.2 V, as is shown in the left panel of Figure 18. The "Charging Current" can be plotted as a function of the potential as shown in the right panel of Figure 18. The "Charging Current" is current used by the **Charge Surfaces** module. *Note that for charging using tracked currents, the* **Charge Surfaces** module does not update the charging current at the end of the timestep. Therefore the charging current is that calculated by tracking in the potentials of the previous timestep. Thus the second (repeated) current value should be assigned to the first potential value, with an offset of one step continuing down the line. The areas used to convert the current density to current are 6 m², 0.42 m², and 55.6932 m² for the upper body, the tether stub, and the low body respectively. (These values appear in the command window and log file each time the Surface Element Groups are plotted.) Figure 18 shows that the upper, electron-collecting body collects -88 μ A (compared with about 1 mA in the earlier calculation). Fitting the upper body current shows that it is proportional to the 0.291 power of potential, somewhat slower than the 0.5 power predicted by magnetic limiting, and much slower than the linear dependence of the orbit-limited treatment used in the earlier

calculation. The lower, ion-collecting body collects 90 μ A, with very little variation with potential. From the fit to the total current, the true steady-state upper body potential is predicted to be 9.4 V. The fitting parameters may differ by a fraction of a percent from those shown here. The currents are displayed with limited precision, and variations in the exact location of the tether stub can lead to small changes in the potential solution.





4.3.2 Particle tracker output file

It is well worth noting some of the information in the Particle Tracker output file. Open the last such file, "GriddedTether_tracker_trajE_10_out.txt", with a text editor that shows line numbers.

- 1. Up through line 30 the input parameters are defined. More current and complete definitions can be found in the Nascap-2k User's Manual.
- 2. Lines 31-50 review some of the grid and problem parameters. Note on line 49 the Z component of CXYZOffset. This is the location of the center of the object relative to the center of the primary grid (containing the lower body). Since we placed the upper body at -200 m in Z, the value of -99.475 seems about right.
- 3. Lines 51 through 84 echo the received input. Further processing of the input goes through line 118. Note that lines 72-74 contain the numbers we entered into the Advanced Particle Parameters dialog box in Section 4.2, with the caveat that no grid information would be available at the time the input files are generated. These numbers appear translated to grid units on lines 106-107. The value of -1527.5 is the offset (in grid units of 13 cm) of the –Z face of the upper grid from the –Z face of the lower, primary grid.
- 4. Lines 120 through 139 summarize the existing set of electron macroparticles, which in this case consists of electron macroparticles newly generated at the sheath surface. The "Weight" of these particles is the total current in amperes, which in this case is 291 μ A.
- 5. Lines 140-147 give the results of tracking those macroparticles. The 88 μ A cited as "dead" represent the current to the upper body. The remaining 203 μ A were magnetically shielded from the upper body, and eventually left the grid.

6. Lines 170-192 give a history of the particle tracking results, including both ions and electrons. The "Collected" current decreases with time, approaching current balance. The "Lost" current, representing electrons that have left the grid, increases with time, representing the growth of the sheath with increasing potential while most of the sheath current is magnetically shielded from the object.

4.3.3 Electron trajectories

Nascap-2k can be used to visualize the trajectories of sheath- and magnetically limited electrons. Go to the **Results3D** tab, and set the view to be from the Y axis, i.e., along the magnetic field. As nothing is visible, click the "Zoom Out" button about fifteen times until the upper *and* lower bodies appear on the screen. As the upper body appears on the bottom, click one of the circle-arrow buttons six times to move the Z-axis from pointing up to pointing down. Now use the up and down buttons and the zoom in button to center the upper body and zoom in on it. Plot potential contours in the Y=0 plane, setting the minimum of the potential scale to 0.0. The image should be similar that shown in Figure 19. Note that the potential contours are made short-range by the plasma screening and are compressed on the ram side and elongated on the wake side.

Now add electron trajectories to the image. Click the "Specify Trajectories..." button. In the **Particle Visualization** dialog box, request electrons on the "Contour" with potential 1 V (the value used for the sheath boundary) in the Y=0 plane (the contour plane plotted). For the plotting limits and the tracking limits, make sure the lower Z limit is a large negative number. In the "Weed" line, specify that every tenth particle is to be plotted. Click the "OK" button. The image should be similar to the left panel of Figure 21, showing that the generated electrons $\mathbf{E} \times \mathbf{B}$ drift around the 1 V contour and are magnetically insulated from the Upper Body.

Use the rotate button \square to rotate the view so that the X-axis points out of the screen and the Y-axis points to the right. Hide the Y=0 cutplane and plot a new cutplane for X=0, again setting the minimum potential to 0.0 V. Generate visualization particles along the X=0, 1 V contour. As on the right panel of Figure 21, the particles move back and forth along the magnetic field direction (Y-direction). Only a few reach the upper body.

4.3.4 Ion trajectories

Viewing the system from the Y-axis with Z pointing down, zoom out to find the lower body, center it, and zoom in on it. Plot potentials in the Y=0 plane to obtain an image similar to the left panel of Figure 22. Click "Specify Trajectories…" to bring up the **Particle Visualization** dialog box. Set it to "Contour" with potential of 1 V in the Y=0.5 m plane. (The particle generation contour plane location is chosen so that the trajectories will appear in front of the potential contour plot.) Make sure the "Oxygen" species is checked. Set the "Weed" parameter to 3. Click the "OK" button. The image should be similar to the right panel of Figure 22.

Most of the ions enter from the right, traveling leftward with the ram ion velocity plus a smaller thermal component. Those generated with a vertical location within about 2.5 m of the cylinder axis impact the lower body; those generated further out are deflected by the potentials and leave the computational space. On the wake side of the contour, low-weight thermal ions are launched and strike the lower body. To see the incident ion current density on the lower body, hide the trajectories and contour plane and select "Tracked Current" for the spacecraft display. Results

are shown in Figure 23. Use the **Results**" tab to determine the mean ion current to the ram side of the lower body. It is 2.3 μ A m⁻², while that to the wake side is 0.84 μ A m⁻². These numbers compare with the raw ram ion current (Nev) of 1.2 μ A m⁻².



Figure 19. Potential contours around the upper body.

Particle visualization X							
Plot: Traiectories							
r Initial Particle Distribution for Trajectories							
Contour Potential Value (V): 1.000 Plane: Y = 0.0							
Sheath Potential Value (V):0.0							
O B Field Number per zone: 0							
⊖ Boundary *							
O Boundary Injection Split particles							
◯ Surface * Emitter ▼ ▼							
○ None of above							
External File Filename: particles bt Browse Split particles							
*Additional parameters on advanced screen.							
Double click species to change trajectory color Color trajectory by particle kinetic energy Plotting Parameters Plotting First (m)							
Yielding limits (m): Tracking limits (m): X: -4.4200 Y: -8.3200 Z: -300.0000 4.4200 Z: -300.0000 4.4200 Z: -300.0000							
✓ Weed: Track every 10 macroparticle							
OK Cancel Advanced							

Figure 20. Particle visualization dialog box used to generate Figure 21 (left panel).



Figure 21. Particle trajectories of electron macroparticles generated along Y=0 contour (left panel) and along X=0 contour (right panel).



Figure 22. Sheath potentials (left panel) and ion trajectories (right panel) near the lower body.



Figure 23. Incident ion current density on wake side (left), and ram side (right) of the lower body.

4.4 Examine results with resistive coupling

Next, perform the same simulation with the lower body resistively coupled to the tether stub rather than shorted to it. The easiest way to do this is to copy the input files, along with the project file, into a new directory, make some minor alterations, and run the new problem from scratch.

Create a new directory, and copy into it the files: GriddedTether.grd, GriddedTetherObject.xml, GriddedTetherProject.xml, and UpperObject.xml.

Open the project file with *Nascap-2k*. Leave the problem type and environment as is. On the **Applied Potentials** tab, in the top panel, change conductor 3 (lower body) from Biased to Floating. In the center panel, add a resistance of $1 \times 10^5 \Omega$ between conductors 3 and 2. On the **Charging** tab, increase the "Number of Timesteps" to 15, with a corresponding duration increase to 0.3 ms.

On the **Script** tab, note that the "Script out of Date" message is showing. This is because the number of iterations has been changed from 10 to 15, and this parameter is not automatically updated in the script for low-Earth-orbit (dense plasma) charging simulations. The existing script can be edited or a new default script can be built. As the default script would also need to be edited, the following instructions take the first approach.

Switch to the **Edit Script** subtab, where there are three **Charge Surfaces** commands. In the first **Charge Surfaces** command (following **Embed Object In Grid**), note that the "SetCircuit" second level command now contains one "ConductorBias" specification and one "Conductance" specification corresponding to the changes made on the **Applied Potentials** tab. In the second **Charge Surfaces** command (preceding **Loop**), the "SetCircuit" second level command has not been updated. *Nascap-2k* automatically updates the parameters associated with *only* the first instance of each command. This is to avoid overwriting any special settings the user may have added. Here the "SetCircuit" second level command needs to be updated. To do this, delete the command (using the "Delete Item" button) and replace it (using the ">>Add Command>>" button) with a new "SetCircuit" second level command. Repeat for the third **Charge Surfaces** command (within the **Loop** command). In the **Loop** command, set the number of iterations to be 14. (One additional iteration is performed outside the **Loop**.) Finally, click the "Run Script" button to execute the script.

As above, plot the potentials of the three bodies over time and the upper body current and total current as a function of upper body potential. Results are shown in Figure 24. Comparing with the shorted case (Figure 18):

- 1. The lower body is about 8 V positive relative to the tether stub, rather than being at nearly the same potential.
- 2. The upper body collects a maximum of about 80 μ A, compared with 88 μ A in the shorted case.
- 3. Extrapolating the total current gives a steady-state upper body potential of 6.85 V, compared with 9.4 V for the shorted case.
- 4. The voltage dependence of the upper body current is again well under the expected 0.5 power.

Uncheck the three "Surface Element Groups" and instead check the three "Conductor" rows and plot their potential. These values are referenced to the same point at the center of the object. If you take differences of these potentials, the $\mathbf{v} \times \mathbf{B}$ contributions cancel, and you obtain the values that would be measured by conventional voltmeters. Figure 25 compares the potential difference between the lower body and tether stub with the IR voltage inferred from the upper body collected current. After some initial transient behavior these two values match at about 8 V.



Figure 24. For the resistive $(100 \text{ k}\Omega)$ case, potentials of the three components versus time (left panel), and upper body and total currents versus upper body potential (right panel).



Figure 25. Measured lower body to stub potential difference (blue curve), compared with value inferred from upper body current flowing through 100 k Ω resistor (orange curve).

4.5 Examine results with smaller upper body

If the upper body is smaller, it will need to go to higher potential in order to collect enough electrons to balance the ram ion current to the lower body. To do this copy the basic input files, along with the project file, into a new directory, make some minor alterations, and run the new problem from scratch.

Create a new directory, and copy into it the files GriddedTether.grd, GriddedTetherObject.xml, GriddedTetherProject.xml, and UpperObject.xml.

Use *Object Toolkit* (by selecting it from the *Windows Start Menu*) to edit **UpperObject.xml**. Highlight the box and click "Edit Component" on the **Edit** menu. Change "X Size", "Y Size", and Z Size" from 1.0 m to 0.7 m to create an object with about half the previous cross-section area. Save the object and exit *ObjectToolkit*.

Open the project file with *Nascap-2k*. On the **Applied Potentials** tab, make sure conductors 2 and 3 are biased to conductor 1 by 0 volts. On the **Charging** tab, set the parameters for 15

timesteps with a minimum of 20 microseconds and a duration of 0.3 milliseconds. The **Space Potentials** tab should specify non-linear charge density, geometric wake initialization with Oxygen, and a Target RMS error of 10^{-3} V.

On the **Script** tab, note that because the number of iterations was changed, the "Script out of **Date**" message is showing. In the following instructions, this message is ignored as the existing script is edited. On **Edit Script** subtab, make sure the **Append Object** command specifies the correct path to the newly-saved **UpperObject.xml** file. There are three **Charge Surfaces** commands. Make sure their "SetCircuit" second level commands correspond to the specifications on the **Applied Potentials** tab. If not, delete the outdated versions and replace them with new ones. Make sure the **Loop** command specifies 14 iterations starting at 1.

Results are shown in Figure 26. The upper body steady-state potential is estimated at 15.5 V, collecting current of 81 μ A (remembering that the area was reduced to 2.94 m²). As expected, the upper body potential is higher but the current is about the same, as it must balance the ram ion current collected by the lower body which is only weakly voltage-dependent. The collected current goes as the 0.6 power of the voltage, (compared with the 0.3 power seen in the earlier cases), suggesting that for the smaller object at higher potential, magnetic limiting is more important than sheath limiting.



Figure 26. For the case of smaller upper body, individual body potentials vs. time (left panel), and upper body and total currents vs. upper body potential (right panel).

4.6 Discussion

In this example, *Nascap-2k* was used to simulate an electrodynamic tether, including sheath and magnetic limiting. In the "Tether" example in Section 3, this simulation was performed using analytic currents, with the caveat that the analytic currents were far too high and did not have correct dependencies on the problem parameters. Even in that case, the dependence of upper body potential on resistance could be simulated.

Here we did three variations of the same simulation including the physics of sheath- and magnetically-limited current collection by constructing a computational grid, solving for space potentials, and tracking particles. The parameters used in these simulations are as follows:

- 1. Tether Length of 200 m;
- 2. Magnetic field of 3×10^{-5} Tesla;
- 3. Ram ion collecting lower body;
- 4. Plasma with density 10^9 m^{-3} and temperature 1 eV.

The differences between the cases, along with the results, are shown in Table 1. The interested reader is encouraged to additional simulations to map out dependencies.

Upper Body	1 m cube	1 m cube	0.7 m cube
Resistance	0	100 kΩ	0
Upper Body Potential	9.4 V	6.85 V	15.5 V
Upper Body Current	88 µA	80 µA	81 µA
Power Law	0.3	0.3	0.6

Table 1. Parameters and results for the three calculations presented here.

This advanced example uses several *Nascap-2k* capabilities, including disjoint grids, managing a script, interpreting the Particle Tracker output file, and plotting particle trajectories for visualization.

5 References

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REPORT DOCUMENTATION PAGE							Form Approved OMB No. 0704-0188	
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1. REPORT DATE (DD-MM-YYYY) 2. REPORT TYPE							3. DATES COVERED (From - To)	
07/10/2023 Contractor Report								
4. TITLE AND SUBTITLE						5a. CO		
NASCAP Surface Charging Tool Development						80NIS9	80NSSC20P2022	
Nascap-2k Additional Examples								
50 50 50 50 50 50 50 50 50 50 50 50 50 5						50. GR	50. GRANT NUMBER	
						5c. PR	PROGRAM ELEMENT NUMBER	
6. AUTHOR(S) 5d.						5d. PR	PROJECT NUMBER	
5e.							SK NUMBER	
5f.							NORK UNIT NUMBER	
7. PERFORMIN	IG ORGANIZATIO	N NAME(S) AND	DADDRESS(ES)				8. PERFORMING ORGANIZATION	
NASA Langley Research Center							REPORT NUMBER	
Hampton, VA 23681-2199								
9. SPONSORING/MONITORING AGENCY NAME(S) AND ADDRESS(ES)							NASA	
Washington DC 20546-0001							NASA	
						-	11 SPONSOR/MONITOR'S REPORT	
							NUMBER(S)	
							NASA/CR-20230010099	
12. DISTRIBUTION/AVAILABILITY STATEMENT								
Unclassified - Unlimited								
Subject Category Computer Programming and Software								
Availability: NASA STI Program (757) 864-9658								
13. SUPPLEMENTARY NOTES								
14. ABSTRACT								
The Nascap-2k computer code is used to analyze interactions between spacecraft surfaces and the plasma environment.								
This document augments the Nascap-2k User's Manual by providing examples designed to assist experienced users with								
modeling moderately complex interactions.								
15. SUBJECT TERMS								
Charge Plate Analyzer; Nascap-2k; Surface Charging Tool								
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